

## ZIITEK ELECTRONIC MATERIAL & TECHNOLOGY CO.,LTD

## TIF<sup>TM</sup>700HZ Thermally Conductive Gap Filler Pads Series

ermally Conductive Gap Filler Pads Series



TIF<sup>TM</sup>700HZ Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effecitly enhances the efficiency and life-time of the heat-generating electronic components.

_	_	_	4	 -	_	_
_	μ	-	т	r	$\boldsymbol{\mu}$	<u>~</u>

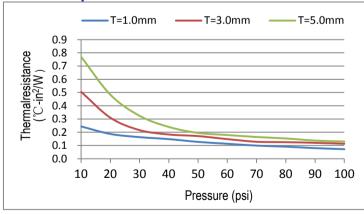
- » Good thermal conductivity
- » Naturally tacky needing no further adhesive coating
- Soft and Compressible for low stress applications
- » Available in varies thickness

## **Application**

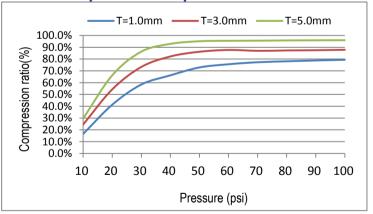
- » Cooling components to the chassis of frame
- » Set Top Box
- » Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting
- » Graphics Card Thermal Module

Typical Properties of TIF <sup>™</sup> 700HZ Series					
Property	Value	Test method			
Color	Blue	Visual			
Construction	Ceramic filled silicone elastomer	*****			
Thickness range	0.020"(0.5mm)~0.200" (5.0mm)	ASTM D374			
Hardness (Shore 00 Thickness≥1.0mm)	45±5	ASTM 2240			
Hardnes (Shore00 Thickness<1.0mm)	55±5	ASTM 2240			
Density (g/cm³)	3.3	ASTM D792			
Operating Temp	-40~160℃	*****			
Dielectric Breakdown Voltage (T=1.0mm, Vac)	≥5500	ASTM D149			
Dielectric Constant@1MHz	4.5	ASTM D150			
Volume Resistivity	≥1.0X10 <sup>12</sup> Ohm-cm	ASTM D257			
Thormal Conductivity (M/m/)	7.0	ASTM D5470			
Thermal Conductivity (W/mK)	7.0	ISO22007-2.2			
Flame Rating	94 -V0	UL E331100			





psi. vs. Compression Ratio



**Product Thicknesses:** 0.020-inch to 0.200-inch (0.5mm to 5.0mm) **Product Sizes:** 8" x 16"(203mm x406mm) Individual die cut shapesand and custom thickness can be supplied. Please contact us for confirming Safe disposal method does not require special protection. The storage condition is low temperature and dry, away from open fire and away from direct sunlight. For detailed method, please refer to the product material safety data sheet.

Thermally Conductive Materials Thermally Conductive Plastics Heat Generating Materials Shielding Materials Foaming Silica Gel

Canada:

Tel:+001-604-2998559 E-mail: sales@thermazig.com China:

Tel: +86-769-38801208 E-mail: frances@ziitek.com.tw Taiwan:
Tel:+886-2-22771007
E-mail:frances@ziitek.com.tw



The information and statements herein are believed to be reliable but are not to be construed as a warranty or representation for which we assume legal responsibility. Users should undertake sufficient verification and testing to determine the suitability for their own particular purpose of any information or products referred to herein.